Integrated High Power Vcsel Systems Philips Photonics

Contributions on UML address the application of UML in the specification of embedded HW/SW systems. C-Based System Design embraces the modeling of operating systems, modeling with different models of computation, generation of test patterns, and experiences from case studies with SystemC. Analog and Mixed-Signal Systems covers rules for solving general modeling problems in VHDL-AMS, modeling of multi-nature systems, synthesis, and modeling of Mixed-Signal Systems with SystemC. Languages for formal methods are addressed by contributions on formal specification and refinement of hybrid, embedded and real-time stems. Together with articles on new languages such as SystemVerilog and Software Engineering in Automotive Systems the contributions selected for this book embrace all aspects of languages and models for specification, design, modeling and verification of systems. Therefore, the book gives an excellent overview of the actual state-of-the-art and the latest research results. Dramatic increases in processing power have rapidly scaled on-chip aggregate bandwidths into the Tb/s range. This necessitates a corresponding increase in the amount of data communicated between chips, so as not to limit overall system performance. To meet the increasing demand for interchip communication bandwidth, researchers are investigating the use of high-speed optical interconnect architectures. Unlike their electrical counterparts, optical interconnects offer high bandwidth and

negligible frequency-dependent loss, making possible per-channel data rates of more than 10 Gb/s. High-Speed Photonics Interconnects explores some of the groundbreaking technologies and applications that are based on photonics interconnects. From the Evolution of High-Speed I/O Circuits to the Latest in Photonics Interconnects Packaging and Lasers Featuring contributions by experts from academia and industry, the book brings together in one volume cutting-edge research on various aspects of high-speed photonics interconnects. Contributors delve into a wide range of technologies, from the evolution of high-speed input/output (I/O) circuits to recent trends in photonics interconnects packaging. The book discusses the challenges associated with scaling I/O data rates and current design techniques. It also describes the major high-speed components, channel properties, and performance metrics. The book exposes readers to a myriad of applications enabled by photonics interconnects technology. Learn about Optical Interconnect Technologies Suitable for High-Density Integration with CMOS Chips This richly illustrated work details how optical interchip communication links have the potential to fully leverage increased data rates provided through complementary metal-oxide semiconductor (CMOS) technology scaling at suitable power-efficiency levels. Keeping the mathematics to a minimum, it gives engineers, researchers, graduate students, and entrepreneurs a comprehensive overview of the dynamic landscape of high-speed photonics interconnects.
Sensor Systems SimulationsFrom Concept to SolutionSpringer

Throughout the world, there is an increasing demand on diminishing natural resources in the industrial, transport, commercial, and residential sectors. Of these, the residential sector uses the most energy on such needs as lighting, water heating, air conditioning, space heating, and refrigeration. This sector alone consumes one-third of the total primary energy resources available. By using green building and smart automation techniques, this demand for energy resources can be lowered. Green Building Management and Smart Automation is an essential scholarly publication that provides an in-depth analysis of design technologies for green building and highlights the smart automation technologies that help in energy conservation, along with various performance metrics that are necessary to facilitate a building to be known as a "Green Smart Building." Featuring a range of topics such as environmental quality, energy management, and big data analytics, this book is ideal for researchers, engineers, policymakers, government officials, architects, and students.

This book is an authoritative review of current and future trends in the field of telecommunications. Written by industry experts who are developing leading-edge data communication networks, Fiber Optic Data Communication provides professionals and students alike with a look at emerging technologies and their applications. Four of the chapters have been revised from DeCusatis's best-selling book, Handbook of Fiber Optic Data Communications; the remaining eight chapters are all new. Seven helpful appendices, a glossary, and a list of technical acronyms are included. This book can

stand alone or as a companion volume to DeCusatis: Handbook of Fiber Optic Data Communication, Second Edition (February 2002, ISBN: 0-12-207891-8). Includes emerging technologies such as Infiniband, 10 Gigabit Ethernet, and MPLS Optical Switching Describes leading edge commercial products, including LEAF and MetroCore fibers, dense wavelength multiplexing, and Small Form Factor transceiver packages Covers all major industry standards, often written by the same people who designed the standards themselves Includes an expanded listing of references on the World Wide Web, plus hard-to-find references for international, homologation, and type approval requirements Convenient tables of key optical datacom parameters and glossary with hundreds of definitions and acronyms Industry buzzwords explained, including SAN, NAS, and MAN networking Datacom market analysis and future projections from industry leading forecasters

Over the last three decades, interest in Infrared (IR) technology as a medium to convey information has grown considerably. This is reflected by the increasing number of devices such as laptops, PDAs, and mobile phones that incorporate optical wireless transceivers and also by the increasing number of optical wireless links available for indoor and

As optical technologies move closer to the core of modern computer architecture, there arise many challenges in building optical capabilities from the network to the motherboard. Rapid advances in integrated optics technologies are making

this a reality. However, no comprehensive, up-to-date reference is available to the technologies and principles underlying the field. The Encyclopedic Handbook of Integrated Optics fills this void, collecting the work of 53 leading experts into a compilation of the most important concepts, phenomena, technologies, and terms covering all related fields. This unique book consists of two types of entries: the first is a detailed, full-length description; the other, a concise overview of the topic. Additionally, the coverage can be divided into four broad areas: A survey of the basics of integrated optics, exploring theory, practical concerns, and the fundamentals behind optical devices Focused discussion on devices and components such as arrayed waveguide grating, various types of lasers, optical amplifiers, and optoelectronic devices In-depth examination of subsystems including MEMS, optical pickup, and planar lightwave circuits Finally, systems considerations such as multiplexing, demultiplexing, 3R circuits, transmission, and reception Offering a broad and complete treatment of the field, the Encyclopedic Handbook of Integrated Optics is the complete guide to the fundamentals, principles, and applications of integrated optics technology. This dissertation provides the first systematic analysis of the dynamic energy efficiency of vertical-cavity surface-emitting lasers (VCSELs) for optical interconnects, a key technology to address the pressing ecological and economic

issues of the exponentially growing energy consumption in data centers. Energy-efficient data communication is one of the most important fields in "Green Photonics" enabling higher bit rates at significantly reduced energy consumption per bit. In this thesis the static and dynamic properties of GaAs-based oxide-confined VCSELs emitting at 850 nm and 980 nm are analyzed and general rules for achieving energy-efficient data transmission using VCSELs at any wavelength are derived. These rules are verified in data transmission experiments leading to record energy-efficient data transmission across a wide range of multimode optical fiber distances and at high temperatures up to 85°C. Important trade-offs between energy efficiency, temperature stability, modulation bandwidth, low current-density operation and other VCSEL properties are revealed and discussed.

Introduction to Fiber-Optic Communications provides students with the most up-to-date, comprehensive coverage of modern optical fiber communications and applications, striking a fine balance between theory and practice that avoids excessive mathematics and derivations. Unlike other textbooks currently available, this book covers all of the important recent technologies and developments in the field, including electro-optic modulators, coherent optical systems, and silicon integrated photonic circuits. Filled with practical, relevant

worked examples and exercise problems, the book presents complete coverage of the topics that optical and communications engineering students need to be successful. From principles of optical and optoelectronic components, to optical transmission system design, and from conventional optical fiber links, to more useful optical communication systems with advanced modulation formats and high-speed DSP, this book covers the necessities on the topic, even including today's important application areas of passive optical networks, datacenters and optical interconnections. Covers fiber-optic communication system fundamentals, design rules and terminologies Provides students with an understanding of the physical principles and characteristics of passive and active fiber-optic components Teaches students how to perform fiber-optic system design, performance evaluation and troubleshooting Includes modern advances in modulation and decoding strategies

This book on Advance Elements of Laser circuits and systems Nonlinearity applications in engineering addresses two separate engineering and scientific areas, and presents advanced analysis methods for Laser circuits and systems that cover a broad range of engineering and scientific applications. The book analyzed Laser circuits and systems as linear and nonlinear dynamical systems and there limit cycles, bifurcation, and limit cycle stability by using nonlinear

dynamic theory. Further, it discussed a broad range of bifurcations related to Laser systems and circuits, starting from laser system differential equations and their bifurcations, delay differential equations (DDEs) are a function of time delays, delay dependent parameters, followed by phase plane analysis, limit cycles and their bifurcations, chaos, iterated maps, period doubling. It combines graphical information with analytical analysis to effectively study the local stability of Laser systems models involving delay dependent parameters. Specifically, the stability of a given steady state is determined by the graphs of some functions of which can be expressed explicitly. The Laser circuits and systems are Laser diode circuits, MRI system Laser diode circuitry, Electron-photon exchanges into VCSEL, Ti: Sapphire laser systems, Ion channel and long-wavelength lasers, Solid state lasers, Solid state laser controlled by semiconductor devices, microchip solid-state laser, Q-switched diode-pumped solid-state laser, Nd:YAG, Mid-Infrared and Q-switched microchip lasers, Gas laser systems, copper vapor laser (CVL) circuitry, Dual-wavelength laser systems, Dual-wavelength operation of a Ti:sapphire laser, Diode-pumped Q-switched Nd:YVO4 yellow laser, Asymmetric dual quantum well lasers, Tm3+-doped silica fibre lasers, Terahertz dual-wavelength quantum cascade laser. The Book address also the additional areas, Laser X guiding system, Plasma diagnostics, Laser Beam shaping, Jitter

and crosstalk, Plasma mirror systems, and High power Laser/Target diagnostic system optical elements. The book is unique in its emphasis on practical and innovative engineering and scientific applications. All conceptual Laser circuits are innovative and can be broadly implemented in many engineering applications. The dynamics of Laser circuits and systems provides several ways to use them in a variety of applications covering wide areas. This book is aimed at electrical and electronics engineers, students and researchers in physics as well. It is also aimed for research institutes in lasers and plasma physics and gives good comprehensive in laser and plasma systems. In each chapter, the concept is developed from basic assumptions up to the final engineering and scientific outcomes. The scientific background is explained at basic and advance levels and closely integrated with mathematical theory. Many examples are presented in this book and it is also ideal for intermediate level courses at graduate level studies. It is also ideal for engineer who has not had formal instruction in nonlinear dynamics, but who now desires to fill the gap between innovative Laser circuits/systems and advance mathematical analysis methods This volume contains the proceedings from the workshops held in conjunction with the IEEE International Parallel and Distributed Processing Symposium, IPDPS 2000, on 1-5 May 2000 in Cancun, Mexico. The workshopsprovidea

forum for bringing together researchers,practiti- ers, and designers from various backgrounds to discuss the state of the art in parallelism.Theyfocusondi erentaspectsofparallelism,fromruntimesystems to formal methods, from optics to irregular problems, from biology to networks of personal computers, from embedded systems to programming environments; the following workshops are represented in this volume: { Workshop on Personal Computer Based Networks of Workstations { Workshop on Advances in Parallel and Distributed Computational Models { Workshop on Par. and Dist. Comp. in Image, Video, and Multimedia { Workshop on High-Level Parallel Prog. Models and Supportive Env. { Workshop on High Performance Data Mining { Workshop on Solving Irregularly Structured Problems in Parallel { Workshop on Java for Parallel and Distributed Computing { WorkshoponBiologicallyInspiredSolutionsto ParallelProcessingProblems { Workshop on Parallel and Distributed Real-Time Systems { Workshop on Embedded HPC Systems and Applications { Recon gurable Architectures Workshop { Workshop on Formal Methods for Parallel Programming { Workshop on Optics and Computer Science { Workshop on Run-Time Systems for Parallel Programming { Workshop on Fault-Tolerant Parallel and Distributed Systems All papers published in the workshops proceedings were selected by the p- gram committee on the basis of referee reports. Each

paper was reviewed by independent referees who judged the papers for originality, quality, and cons- tency with the themes of the workshops.

This book comprises selected contributions to the Computer Society of India's annual convention. Divided into 10 topical volumes, the proceedings present papers on state-of-the-art research, surveys and succinct reviews, covering diverse topics ranging from communications networks to big data analytics, and from system architecture to cyber security. This volume focuses on silicon photonics & high performance computing, offering valuable insights for researchers and students alike.

Optical trapping and manipulation by laser beams offers the unique possibility to handle single micrometer-sized particles such as living cells without any mechanical contact, damage or contamination. A second hot topic in biology is microfluidics, where the examination of biological samples in channel structures with widths below 100 µm reduces the used sample volume significantly. While the combination of both techniques results in attractive lab-on-a-chip structures for particle sorting and analysis, the commonly bulky trapping setup is contradictory to the miniaturized concept. Here, the use of vertical-cavity surface-emitting lasers (VCSELs) as light sources in optical trapping systems allows a strong reduction of the setup complexity owing to the small dimensions, low cost

and high beam quality of these devices. This thesis gives a detailed study on optical manipulation systems based on vertically emitting laser diodes. A standard optical tweezers setup as well as a novel, miniaturized system, the so-called integrated optical trap are investigated. The latter aims for particle separation and sorting in microfluidics resulting in low-cost, portable modules. A classical optical tweezers system based on a high numerical aperture objective in combination with a VCSEL light source is investigated. Standard multi-mode as well as single-mode surface relief VCSELs are used as laser source. With both kinds of VCSELs, optical trapping of polystyrene particles of sizes ranging from 4 to 15μm is demonstrated with some milliwatts of optical power at the sample stage. A maximum trapping force of 4.4 pN for 15 μm particles is achieved with the multi-mode laser, proving the suitability of multi-mode lasers for optical manipulation despite their inferior beam profile. By using two-dimensional VCSEL arrays instead of solitary lasers, the system is extended to a multiple optical tweezers setup in a straightforward manner. To avoid any additional optics, densely packed VCSEL arrangements with a device spacing of less than 25 μm are used, where a novel fabrication process allows the seamless integration of the inverted surface relief technique for enhanced beam quality. By electrical switching between individual devices of the array, non-mechanical particle

translation with velocities of up to 12 µm/s is achieved. With a tilted linear VCSEL array, an optical lattice is generated in the optical tweezers setup, and continuous deflection of particles is realized. By substituting the sample stage in the optical tweezers setup with a microfluidic chip fabricated from polydimethylsiloxane (PDMS), particle redirection at a channel junction is realized using a solitary VCSEL source as well as a tilted linear VCSEL array. For the latter, the particles are deflected when passing the optical lattice, thus, the position of the lasers is fixed and no moving parts are necessary, which further reduces the setup complexity. To achieve a drastic miniaturization of the trapping setup, namely the integrated optical trap, the laser source is placed directly underneath the sample chamber. A weakly focused laser beam is generated in the particle solution by integrating an additional microlens on the VCSEL output facet. To determine appropriate lens geometries, the beam propagation inside the integrated trap structure is calculated and the thermal reflow process for lens fabrication is studied in detail concerning lens diameter, reflow temperature and substrate material. By combining the microlens with the inverted relief technique, the quality of the focused beam is strongly improved with respect to divergence, transverse beam profile and beam diameter, where a minimum of 7 µm is measured at the focal point. With first solitary integrated optical traps, deflection,

levitation and transverse trapping of 10 µm polystyrene particles is demonstrated for optical powers of 5mW. In a next step, integrated optical trap arrays are realized based on closely spaced twodimensional arrangements of lensed relief VCSELs. To transfer the continuous deflection scheme demonstrated in the classical tweezers setup to the integrated trap, linear arrays of parallel working VCSELs are investigated. To support the design of the multiple integrated trap structure, a simulation of the optical deflection process is performed. Here, a dependence on the geometric and material properties of the particles is predicted, so applications in microfluidic particle sorting are intended. Compact and portable modules are obtained by integrating the laser chip with the microfluidic chip using flip-chip bonding. Although the finished modules show strong heating of the VCSEL chip resulting in a significant reduction of the device performance, simultaneous trapping as well as continuous particle deflection was successfully demonstrated with a total optical power of just 5mW. The results presented in this work demonstrate the potential of VCSELs as laser sources for optical trapping and microparticle manipulation. In conventional optical tweezers setups, the use of VCSELs reduces the setup complexity significantly, while first prototypes of ultra-compact integrated optical traps based on VCSELs confirm the feasibility of portable and inexpensive microfluidic sorting systems.

This book describes for readers various technical outcomes from the EU-project IoSense. The authors discuss sensor integration, including LEDs, dust sensors, LIDAR for automotive driving and 8 more, demonstrating their use in simulations for the design and fabrication of sensor systems. Readers will benefit from the coverage of topics such as sensor technologies for both discrete and integrated innovative sensor devices, suitable for high volume production, electrical, mechanical, security and software resources for integration of sensor system components into IoT systems and IoT-enabling systems, and IoT sensor system reliability. Describes from component to system level simulation, how to use the available simulation techniques for reaching a proper design with good performance; Explains how to use simulation techniques such as Finite Elements, Multi-body, Dynamic, stochastics and many more in the virtual design of sensor systems; Demonstrates the integration of several sensor solutions (thermal, dust, occupancy, distance, awareness and more) into large-scale system solutions in several industrial domains (Lighting, automotive, transport and more); Includes state-of-the-art simulation techniques, both multi-scale and multi-physics, for use in the electronic industry.

Optical Fiber Telecommunications VI (A&B) is the sixth in a series that has chronicled the progress in the R&D of lightwave communications since the early

1970s. Written by active authorities from academia and industry, this edition brings a fresh look to many essential topics, including devices, subsystems, systems and networks. A central theme is the enabling of high-bandwidth communications in a cost-effective manner for the development of customer applications. These volumes are an ideal reference for R&D engineers and managers, optical systems implementers, university researchers and students, network operators, and investors. Volume A is devoted to components and subsystems, including photonic integrated circuits, multicore and few-mode fibers, photonic crystals, silicon photonics, signal processing, and optical interconnections. All the latest technologies and techniques for developing future components and systems Edited by two winners of the highly prestigious OSA/IEEE John Tyndal award and a President of IEEE's Lasers & Electro-Optics Society (7,000 members) Written by leading experts in the field, it is the most authoritative and comprehensive reference on optical engineering the market This book explains for readers how 3D chip stacks promise to increase the level of on-chip integration, and to design new heterogeneous semiconductor devices that combine chips of different integration technologies (incl. sensors) in a single package of the smallest possible size. The authors focus on heterogeneous 3D integration, addressing some of the most important challenges in this emerging

technology, including contactless, optics-based, and carbon-nanotube-based 3D integration, as well as signal-integrity and thermal management issues in copper-based 3D integration. Coverage also includes the 3D heterogeneous integration of power sources, photonic devices, and non-volatile memories based on new materials systems.

Semiconductors are at the heart of modern living. Almost everything we do, be it work, travel, communication, or entertainment, all depend on some feature of semiconductor technology. Comprehensive Semiconductor Science and Technology captures the breadth of this important field, and presents it in a single source to the large audience who study, make, and exploit semiconductors. Previous attempts at this achievement have been abbreviated, and have omitted important topics. Written and Edited by a truly international team of experts, this work delivers an objective yet cohesive global review of the semiconductor world. The work is divided into three sections. The first section is concerned with the fundamental physics of semiconductors, showing how the electronic features and the lattice dynamics change drastically when systems vary from bulk to a low-dimensional structure and further to a nanometer size. Throughout this section there is an emphasis on the full understanding of the underlying physics. The second section deals largely with the transformation of the conceptual framework

of solid state physics into devices and systems which require the growth of extremely high purity, nearly defect-free bulk and epitaxial materials. The last section is devoted to exploitation of the knowledge described in the previous sections to highlight the spectrum of devices we see all around us. Provides a comprehensive global picture of the semiconductor world Each of the work's three sections presents a complete description of one aspect of the whole Written and Edited by a truly international team of experts

Parallel computing technologies have brought dramatic changes to mainstream computing; the majority of today's PC's, laptops and even notebooks incorporate multiprocessor chips with up to four processors. Standard components are increasingly combined with GPU's (Graphics Processing Unit), originally designed for high-speed graphics processing, and FPGA's (Free Programmable Gate Array) to build parallel computers with a wide spectrum of high-speed processing functions. The scale of this powerful hardware is limited only by factors such as energy consumption and thermal control However, in addition to hardware factors, the practical use of petascale and exascale machines is often hampered by the difficulty of developing software which will run effectively and efficiently on such architecture This book includes selected and refereed papers, presented at the 2009 international Parallel Computing conference (ParCo2009),

which set out to address these problems. It provides a snapshot of the state-of-the-art of parallel computing technologies in hardware, application and software development Areas covered include: numerical algorithms, grid and cloud computing, programming - including GPU and cell programming. The book also includes papers presented at the six mini-symposia held at the conference Wafer-scale integration has long been the dream of system designers. Instead of chopping a wafer into a few hundred or a few thousand chips, one would just connect the circuits on the entire wafer. What an enormous capability wafer-scale integration would offer: all those millions of circuits connected by high-speed on-chip wires. Unfortunately, the best known optical systems can provide suitably ?ne resolution only over an area much smaller than a whole wafer. There is no known way to pattern a whole wafer with transistors and wires small enough for modern circuits. Statistical defects present a ?rmer barrier to wafer-scale integration. Flaws appear regularly in integrated circuits; the larger the circuit area, the more probable there is a ?aw. If such ?aws were the result only of dust one might reduce their numbers, but ?aws are also the inevitable result of small scale. Each feature on a modern integrated circuit is carved out by only a small number of photons in the lithographic process. Each transistor gets its electrical properties from only a small number of impurity atoms in its tiny area. Inevitably,

the quantized nature of light and the atomic nature of matter produce statistical variations in both the number of photons de?ning each tiny shape and the number of atoms providing the electrical behavior of tiny transistors. No known way exists to eliminate such statistical variation, nor may any be possible. Three-Dimensional Integrated Circuit Design, Second Eition, expands the original with more than twice as much new content, adding the latest developments in circuit models, temperature considerations, power management, memory issues, and heterogeneous integration. 3-D IC experts Pavlidis, Savidis, and Friedman cover the full product development cycle throughout the book, emphasizing not only physical design, but also algorithms and system-level considerations to increase speed while conserving energy. A handy, comprehensive reference or a practical design guide, this book provides effective solutions to specific challenging problems concerning the design of three-dimensional integrated circuits. Expanded with new chapters and updates throughout based on the latest research in 3-D integration: Manufacturing techniques for 3-D ICs with TSVs Electrical modeling and closed-form expressions of through silicon vias Substrate noise coupling in heterogeneous 3-D ICs Design of 3-D ICs with inductive links Synchronization in 3-D ICs Variation effects on 3-D ICs Correlation of WID variations for intra-tier buffers and wires Offers practical guidance on designing

3-D heterogeneous systems Provides power delivery of 3-D ICs Demonstrates the use of 3-D ICs within heterogeneous systems that include a variety of materials, devices, processors, GPU-CPU integration, and more Provides experimental case studies in power delivery, synchronization, and thermal characterization

This book provides a comprehensive introduction to integrated optical waveguides for information technology and data communications. Integrated coverage ranges from advanced materials, fabrication, and characterization techniques to guidelines for design and simulation. A concluding chapter offers perspectives on likely future trends and challenges. The dramatic scaling down of feature sizes has driven exponential improvements in semiconductor productivity and performance in the past several decades. However, with the potential of gigascale integration, size reduction is approaching a physical limitation due to the negative impact on resistance and inductance of metal interconnects with current copper-trace based technology. Integrated optics provides a potentially lower-cost, higher performance alternative to electronics in optical communication systems. Optical interconnects, in which light can be generated, guided, modulated, amplified, and detected, can provide greater bandwidth, lower power consumption, decreased interconnect delays, resistance to

electromagnetic interference, and reduced crosstalk when integrated into standard electronic circuits. Integrated waveguide optics represents a truly multidisciplinary field of science and engineering, with continued growth requiring new developments in modeling, further advances in materials science, and innovations in integration platforms. In addition, the processing and fabrication of these new devices must be optimized in conjunction with the development of accurate and precise characterization and testing methods. Students and professionals in materials science and engineering will find Advanced Materials for Integrated Optical Waveguides to be an invaluable reference for meeting these research and development goals.

As rapid technological developments occur in electronics, photonics, mechanics, chemistry, and biology, the demand for portable, lightweight integrated microsystems is relentless. These devices are getting exponentially smaller, increasingly used in everything from video games, hearing aids, and pacemakers to more intricate biomedical engineering and military applications. Edited by Kris Iniewski, a revolutionary in the field of advanced semiconductor materials, Integrated Microsystems: Electronics, Photonics, and Biotechnology focuses on techniques for optimized design and fabrication of these intelligent miniaturized devices and systems. Composed of contributions from experts in academia and

industry around the world, this reference covers processes compatible with CMOS integrated circuits, which combine computation, communications, sensing, and actuation capabilities. Light on math and physics, with a greater emphasis on microsystem design and configuration and electrical engineering, this book is organized in three sections—Microelectronics and Biosystems, Photonics and Imaging, and Biotechnology and MEMs. It addresses key topics, including physical and chemical sensing, imaging, smart actuation, and data fusion and management. Using tables, figures, and equations to help illustrate concepts, contributors examine and explain the potential of emerging applications for areas including biology, nanotechnology, micro-electromechanical systems (MEMS), microfluidics, and photonics. Starting from the basics of semiconductor lasers with emphasis on the generation of high optical output power the reader is introduced in a tutorial way to all key technologies required to fabricate high-power diode-laser sources. Various applications are exemplified.

The huge progress which has been achieved in the field is covered here, in the first comprehensive monograph on vertical-cavity surface-emitting lasers (VCSELs) since eight years. Apart from chapters reviewing the research field and the laser fundamentals, there are comprehensive updates on red and blue

emitting VCSELs, telecommunication VCSELs, optical transceivers, and parallel-optical links for computer interconnects. Entirely new contributions are made to the fields of vectorial three-dimensional optical modeling, single-mode VCSELs, polarization control, polarization dynamics, very-high-speed design, high-power emission, use of high-contrast gratings, GaInNAsSb long-wavelength VCSELs, optical video links, VCSELs for optical mice and sensing, as well as VCSEL-based laser printing. The book appeals to researchers, optical engineers and graduate students.

Proceedings of SPIE present the original research papers presented at SPIE conferences and other high-quality conferences in the broad-ranging fields of optics and photonics. These books provide prompt access to the latest innovations in research and technology in their respective fields. Proceedings of SPIE are among the most cited references in patent literature.

Optics and photonics technologies are ubiquitous: they are responsible for the displays on smart phones and computing devices, optical fiber that carries the information in the internet, advanced precision manufacturing, enhanced defense capabilities, and a plethora of medical diagnostics tools. The opportunities arising from optics and photonics offer the potential for even greater societal impact in the next few decades, including solar power generation and new efficient lighting that could transform the nation's energy landscape and new optical capabilities that will be essential to support the continued exponential growth of the Internet. As described in the National Research Council report Optics and Photonics: Essential

Technologies for our Nation, it is critical for the United States to take advantage of these emerging optical technologies for creating new industries and generating job growth. The report assesses the current state of optical science and engineering in the United States and abroad--including market trends, workforce needs, and the impact of photonics on the national economy. It identifies the technological opportunities that have arisen from recent advances in, and applications of, optical science and engineering. The report also calls for improved management of U.S. public and private research and development resources, emphasizing the need for public policy that encourages adoption of a portfolio approach to investing in the wide and diverse opportunities now available within photonics. Optics and Photonics: Essential Technologies for our Nation is a useful overview not only for policymakers, such as decision-makers at relevant Federal agencies on the current state of optics and photonics research and applications but also for individuals seeking a broad understanding of the fields of optics and photonics in many arenas.

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